COMBINED DECLARATION AND POWER OF ATTORNEY

As the below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name and that I believe I am an original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

AUTO-RECOVERY WAFER TESTING APPARATUS AND WAFER TESTING METHOD

X	is attached here	eto.			
	was filed on				
	as Application S	Serial No ar	nd was amended on	•	
appl forei any appl	cification, includir I acknowledge ication in accorda I hereby claim gn application(s)	ng the claims, as amen the duty to disclose in ance with Title 37, Cod foreign priority benefit for patent or inventor on for patent or invent priority is claimed:	and understood the contented ded by any amendment refers formation which is material the of Federal Regulations, § sits under Title 35, United Sits certificate listed below and ator's certificate having a filing	rred to above. to the patental 1.56(a). tates Code, § I have also ide	oility of this 119 of any ntified below
	Number	Country	Date Filed(yyyy/mm/dd)	Yes	No
	93110813	Taiwan, R.O.C.	2004/4/19	X	
			•	• •	ation and to
SE	END CORRESPO	ONDENCE TO:		PHONE CALL	

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COMBINED DECLARATION AND POWER OF ATTORNEY CONTINUED

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.

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